

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	TLS115B0EJ	**Issued**	9. January 2019
MA#	MA003013986		
Package	PG-DSO-8-52	**Weight***	83.72 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.123	1.34	1.34	13412	13412
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		109	
	non noble metal	zinc	7440-66-6	0.036	0.04		435	
	non noble metal	iron	7439-89-6	0.728	0.87		8693	
	non noble metal	copper	7440-50-8	29.548	35.30	36.22	352953	362190
wire	non noble metal	copper	7440-50-8	0.054	0.06	0.06	640	640
encapsulation	organic material	carbon black	1333-86-4	0.101	0.12		1203	
	plastics	epoxy resin	-	4.635	5.54		55360	
	inorganic material	silicondioxide	60676-86-0	45.640	54.51	60.17	545177	601740
leadfinish	non noble metal	tin	7440-31-5	0.695	0.83	0.83	8303	8303
plating	noble metal	silver	7440-22-4	0.725	0.87	0.87	8654	8654
glue	plastics	epoxy resin	-	0.106	0.13		1265	
	noble metal	silver	7440-22-4	0.318	0.38	0.51	3796	5061
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com